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4/20/06

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):

(1) Tae-hwan CHA; (2) Eun-kyung PARK

Execution Date(s) April 19, 2006

Additional name(s) of conveying party(ies) attached?  Yes  No

9. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other \_\_\_\_\_

2. Name and address of receiving party(ies)

Name: Samsung Electronics Co., Ltd.

Internal Address: \_\_\_\_\_

Street Address: 416, Maetan-dong, Yeongtong-gu

City: Suwon-si

State: Gyeonggi-do

Country: Republic of Korea Zip: 442-742

Additional name(s) & address(es) attached?  Yes  No

4. Application or patent number(s):

A. Patent Application No.(s)

This document is being filed together with a new application.

B. Patent No.(s)

04/19/2006 SDIRETA1 00000074 11407051

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(40.00 DP)

Additional numbers attached?  Yes  No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Roylance, Abrams, Berdo & Goodman, L.L.P.

Internal Address: Suite 600

Street Address: 1300 19<sup>th</sup> Street, NW

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6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers \_\_\_\_\_

Expiration Date \_\_\_\_\_

b. Deposit Account Number 18-2220

Authorized User Name John E. Holmes

9. Signature:

*Demetra Smith Stewart*  
Signature

April 20, 2006

Date

Demetra Smith-Stewart  
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

## ASSIGNMENT

WHEREAS, We, (1) CHA, Tae-hwan; and (2) PARK, Eun-kyung, all citizens of the Republic of Korea, residing respectively at (1) Taeyeong Apt. #205-904, Yeongdoek-ri, Giheunh-eup, Yongin-si, Gyeonggi-do, Republic of Korea; and (2) Bada Maeul Apt. #104-1705, Singli-7dong, Yeongdeungpo-gu, Seoul, Republic of Korea (hereinafter "ASSIGNORS"), have made a certain invention entitled "**IMAGE PROCESSING APPARATUS AND IMAGE PROCESSING METHOD**" for which we are making application for Letters Patent of the United States, which application is being executed concurrently herewith; and

WHEREAS, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter "ASSIGNEE"), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all United States Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to us by said ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, we, the ASSIGNORS, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States; and in, to and under the aforesaid United States application and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in the United States; and our right to file said applications and claim priority under the provisions of any international treaty or convention; and in and to any Letters Patent of the United States issued or granted on said invention and/or said applications;

AND WE HEREBY authorize and request the U.S. Patent and Trademark Office or other issuing authority to issue any and all patents on said invention and/or said applications to said ASSIGNEE as sole assignee;

AND WE HEREBY covenant that we have the full right to convey the entire right, title and interest herein assigned and that we have not executed and will not execute any assignment or other instrument in conflict herewith;

AND WE HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable

compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in the United States, and likewise we make these provisions binding upon our heirs, legal representatives and/or administrators.

The undersigned hereby grant the firm of Roylance, Abrams, Berdo & Goodman, L.L.P. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, I have hereunder set my hand and seal this 19 day of APRIL, 2006.

Cha Taehwan

CHA, Tae-hwan

\_\_\_\_\_  
Witness

IN WITNESS WHEREOF, I have hereunder set my hand and seal this 19 day of APRIL, 2006.

Park Eunkyung

PARK, Eun-kyung

\_\_\_\_\_  
Witness